**DETAIL A** 

e/2



## WQFN24, 4x4, 0.5P CASE 510BF **ISSUE 0**

**DATE 16 OCT 2013** 

- DIMENSIONING AND TOLERANCING PER ASME
- THE PROPERTY OF THE PROPERTY O
- FROM THE TERMINAL TIP.

  COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

		MILLIMETERS		
D	IM	MIN	MAX	
	Α	0.70	0.80	
A	۱1	0.00	0.05	
A	١3	0.20 REF		
	b	0.20	0.30	
	D	4.00 BSC		
0	)2	2.40	2.60	
	E	4.00 BSC		
E	2	2.40	2.60	
	е	0.50 BSC		
	L	0.30	0.50	
L	_1	0.00	0.15	

## **GENERIC MARKING DIAGRAM\***



XXXXXX= Specific Device Code

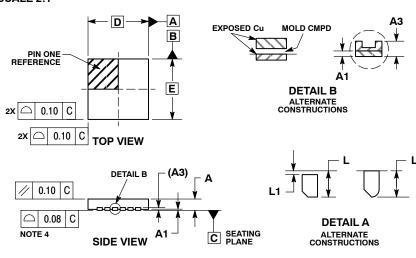
= Assembly Location Α

= Wafer Lot L = Year W = Work Week

= Pb-Free Package (Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■",

may or may not be present.



CAB

0.10

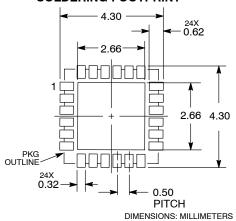
0.05 С NOTE 3

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## **SOLDERING FOOTPRINT\***

<u>andlann</u>

**BOTTOM VIEW** 



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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